







TCAN1046V-Q1

ZHCSIR6C - SEPTEMBER 2018 - REVISED FEBRUARY 2022

TCAN1046V-Q1 双路汽车类故障保护 CAN 收发器

1 特性

- AEC-Q100标准:符合汽车应用要求 - 温度等级 1:-40°C 至 125°C TA
- 两个具有独立模式控制功能的高速 CAN 收发器
- 符合 ISO 11898-2:2016 和 ISO 11898-5:2007 物理 层标准中的要求
- 提供功能安全 - 可帮助进行功能安全系统设计的文档
- 支持传统 CAN 和经优化的 CAN FD 性能(数据速 率为 2、5 和 8Mbps)
 - 具有较短的对称传播延迟时间,可增加时序裕量
 - 在负载型 CAN 网络中实现更快的数据速率
- I/O 电压范围支持 1.7V 至 5.5V
 - 支持 1.8V、2.5V、3.3V 和 5V 应用
- 保护特性:
 - 总线故障保护:±58V
 - 欠压保护
 - TXD 显性超时 (DTO)
 - 数据速率低至 9.2kbps
 - 热关断保护 (TSD)
- 工作模式:
 - 正常模式
 - 支持远程唤醒请求功能的低功耗待机模式
- 优化了未上电时的性能
 - 总线和逻辑引脚为高阻抗 (运行总线或应用上无 负载)
 - 支持热插拔:在总线和 RXD 输出上可实现上电/ 断电无干扰运行
- 结温范围: 40°C 至 150°C
- 接收器共模输入电压:±12V
- 采用 SOIC (14) 封装和无引线 VSON (14) 封装 (4.5mm x 3.0mm),具有改进的自动光学检查 (AOI) 功能

2 应用

- 汽车和运输
 - 车身控制模块
 - 汽车网关
 - 高级驾驶辅助系统 (ADAS)
 - 信息娱乐系统

3 说明

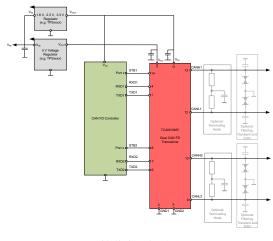
TCAN1046A-Q1 是一款双路高速控制器局域网 (CAN) 收发器,满足 ISO 11898-2:2016 高速 CAN 规范对物 理层的要求。

TCAN1046V-Q1 收发器支持传统 CAN 和 CAN FD 网 络,数据速率高达 8 兆位/秒 (Mbps)。TCAN1046V-Q1 包括通过 VIO 端子实现的内部逻辑电平转换功能,允许 将收发器 IO 直接连接到 1.8V、2.5V、3.3V 或 5V 逻 辑 IO。两个 CAN 通道通过待机引脚支持独立的模式控 制。这提供了在不影响其他 CAN 通道状态的情况下将 每个收发器置于其低功耗状态、待机模式的功能。在待 机模式下, TCAN1046V-Q1 可通过 ISO 11898-2:2016 定义的唤醒模式 (WUP) 实现远程唤醒。此类 TCAN1046V-Q1 收发器还包括很多保护和诊断功能, 支持热关断 (TSD)、TXD 显性超时 (DTO)、电源欠压 检测和高达 ±58V 的总线故障保护。

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器		п	new.

器件型号	封装 ⁽¹⁾	封装尺寸(标称值)
TCAN1046V-Q1	VSON (14)	4.50mm x 3.00mm
	SOIC (14)	8.95mm x 3.91mm

(1) 如需了解所有可用封装,请参阅数据表末尾的可订购产品附 录。



简化版原理图



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4 Revision History 注:以前版本的页码可能与当前版本的页码不同

C	hanges from Revision B (December 2019) to Revision C (February 2022)	Page
•	从数据表中删除了 TCAN1048V-Q1	1
•	将所有 TCAN104xV-Q1 更改为 TCAN1046V-Q1	1
•	添加了 <i>特性</i> "提供功能安全"	1
•	Deleted nSTB1 and nSTB2 pin from the Pin Configuration and Functions and throughout this documen	t <mark>3</mark>
•	Changed the Test Conditions for IOS(SS DOM) in the Electrical Characteristics table	7
•	Deleted the "EMC requirements:" from the Overview secton	14
•	Added footnotes to 表 8-1	19
•	Removed section Related Links from the	29

Changes from Revision A (August 2019) to Revision B (Decembe	er 2019) Page
 首次公开发布数据表 	1
• Changed 9-2	

Cł	hanges from Revision * (September 2018) to Revision A (August 2019)	Page
•	将数据表从 <i>预告信息</i> 更改为量产数据	1



5 Pin Configuration and Functions

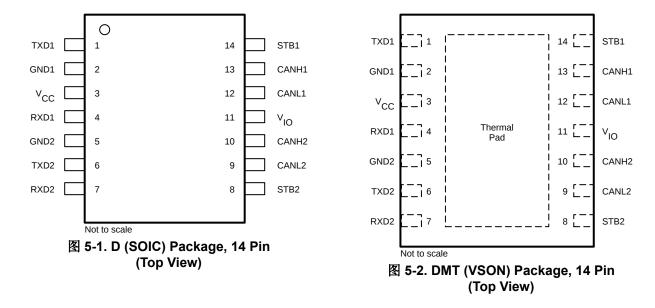


表 5-1. Pin Functions

Pins		Turno	Description		
Name	No.	Туре	Description		
TXD1	1	Digital Input	CAN transmit data input 1, integrated pull-up		
GND1	2	GND	Ground connection		
V _{CC}	3	Supply	√ supply voltage		
RXD1	4	Digital Output	CAN receive data output 1, tri-state when $V_{IO} < UV_{VIO}$		
GND2	5	GND	Ground connection		
TXD2	6	Digital Input	CAN transmit data input 2, integrated pull-up		
RXD2	7	Digital Output	AN receive data output 2, tri-state when $V_{IO} < UV_{VIO}$		
STB2	8	Digital Input	tandby input 2 for mode control, integrated pull-up		
CANL2	L2 9 Bus IO Low-level CAN bus 2 input or output line		Low-level CAN bus 2 input or output line		
CANH2 10 Bus IO Hi		Bus IO	High-level CAN bus 2 input or output line		
V _{IO}	11	Supply	IO supply voltage		
CANL1	12	Bus IO	Low-level CAN bus 1 input or output line		
CANH1	13	Bus IO	High-level CAN bus 1 input or output line		
STB1	14	Digital Input	Standby input 1 for mode control, integrated pull-up		
Thermal Pad (VSON only) —		_	Electrically connected to GND, connect the thermal pad to the printed circuit board (PCB) ground plane for thermal relief		



6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)^{(1) (2)}

		MIN	MAX	UNIT
V _{CC}	Supply voltage	- 0.3	6	V
V _{IO}	Supply voltage I/O level shifter	- 0.3	6	V
V _{BUS}	CAN Bus IO voltage CANH1, CANL1 & CANH2, CANL2	- 58	58	V
V _{DIFF}	Max differential voltage between CANH1, CANL1 & CANH2, CANL2	- 45	45	V
V _{Logic_Input}	Logic input terminal voltage	- 0.3	6	V
V _{RXD}	RXD output terminal voltage range (V _{RXD1} , V _{RXD2})	- 0.3	6	V
I _{O(RXD)}	RXD output current (I _{ORXD1} , I _{ORXD2})	- 8	8	mA
TJ	Operating virtual junction temperature range	- 40	150	°C
T _{STG}	Storage temperature	- 65	150	°C

(1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

(2) All voltage values, except differential IO bus voltages, are with respect to ground terminal.

6.2 ESD Ratings

				VALUE	UNIT
	Electrostatic discharge Human-body model (HBM), per AEC Q100-002 ⁽¹⁾ HBM classification level 3A for all pins HBM classification level 3B for global pins CANH & CANL	±3000	V		
V _{ESD}		±10000	V		
		Charged-device model (CDM), per AEC Q100-011 CDM classification level C5 for all pins	±750	V	

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

6.3 ESD Ratings - IEC Ratings

				VALUE	UNIT
			Pulse 1	- 100	V
	ISO 7637-2 Transients immunity ⁽¹⁾		Pulse 2a	75	V
V _{Tran}	130 7037-2 Transients initiality	CAN bus terminals (CANH1, CANL1 and CANH2, CANL2) to GND	Pulse 3a	- 150	V V V
			Pulse 3b	100	V
	ISO 7637-3 DCC transient immunity ⁽²⁾		DCC slow transient pulse	±85	V

(1) Tested according to IEC 62228-3

(2) Tested according to ISO 7637-3 (2017); Electrical transient transmission by capacitive and inductive coupling via lines other than supply lines

6.4 Recommended Operating Conditions

		MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	4.5	5	5.5	V
V _{IO}	Supply voltage for I/O level shifter	1.7		5.5	V
I _{OH(RXD)}	RXD terminal high level output current - I _{OH(RXD1)} & I _{OH(RXD2)}	- 2			mA
I _{OL(RXD)}	RXD terminal low level output current - I _{OL(RXD1)} & I _{OL(RXD2)}			2	mA
T _A	Operating ambient temperature	- 40		125	°C



6.5 Thermal Characteristics

THERMAL METRIC ⁽¹⁾		TCAN1	UNIT	
		D (SOIC)	DMT (VSON)	
R _{0 JA}	Junction-to-ambient thermal resistance	70.8	34.8	°C/W
R ₀ JC(top)	Junction-to-case (top) thermal resistance	33	38.2	°C/W
R _{0 JB}	Junction-to-board thermal resistance	32.9	12.8	°C/W
ΨJT	Junction-to-top characterization parameter	5.9	2.0	°C/W
Ψ _{JB}	Junction-to-board characterization parameter	32.5	12.8	°C/W
R _{0 JC(bot)}	Junction-to-case (bottom) thermal resistance	-	3.1	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

6.6 Supply Characteristics

Over recommended operating conditions with T_A = -40 $^\circ\!\mathrm{C}$ to 125 $^\circ\!\mathrm{C}$ (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
		Dominant	$\begin{array}{l} TXDx = 0 \; V, \; TXDy = V_{IO} \\ STB1 = STB2 = 0 \; V \\ R_{L} = 60 \; \Omega, \; C_{L} = open \\ See \; \boxtimes \; \textbf{7-1} \end{array}$		50	77.5	mA
		One channel ⁽¹⁾	$\begin{array}{l} TXDx = 0 \; V, \; TXDy = V_{IO} \\ STB1 = STB2 = 0 \; V \\ R_{L} = 50 \; \Omega, \; C_{L} = open \\ See \; \boxtimes \; \textbf{7-1} \end{array}$		55	87.5	mA
		Dominant	TXD1 = TXD2 = 0 V STB1 = STB2 = 0 V $R_L = 60 \Omega, C_L = open$ See 😫 7-1		95	140	mA
Icc		Two channels	TXD1 = TXD2 = 0 V STB1 = STB2 = 0 V $R_L = 50 \Omega, C_L = open$ See 🕅 7-1		100	160	mA
	Supply current normal mode		$\begin{array}{l} TXD1 = TXD2 = V_{IO} \\ STB1 = STB2 = 0 \ V \\ R_{L} = 50 \ \Omega, \ C_{L} = open \\ See \ \fbox{1}7-1 \end{array}$		10	15	mA
		Dominant with bus fault CANx, CANy recessive ^{(1) (2)}	$\begin{array}{l} TXDx = 0 \; V, \; TXDy = V_{IO} \\ STB1 = STB2 = 0 \; V \\ CANHx = CANLx = \pm 25 \; V \\ R_{Lx} = open, \; R_{Ly} = 50 \; \Omega, \; C_{L} = open \\ See \; \boxtimes \; 7\text{-}1 \end{array}$		90	137.5	mA
		Dominant with bus fault CANx, CANy dominant ⁽²⁾	$\label{eq:statestar} \begin{array}{l} TXD1 = TXD2 = 0 \ V \\ STB1 = STB2 = 0 \ V \\ CANHx = CANLx = \pm 25 \ V \\ R_{Lx} = open, \ R_{Ly} = 50 \ \Omega, \ C_{L} = open \\ See \ \fbox{1}7-1 \end{array}$		135	210	mA
		Dominant with bus fault CANx and CANy ⁽²⁾	$\begin{array}{l} TXD1 = TXD2 = 0 \ V \\ STB1 = STB2 = 0 \ V \\ CANH1 = CANL1 = \pm 25 \ V \\ CANH2 = CANL2 = \pm 25 \ V \\ R_{Lx} = R_{Ly} = open, \ C_{L} = open \\ See \ \fbox{1}7-1 \end{array}$		170	260	mA
	Supply current standby mo	de	$\begin{array}{l} \text{TXD1} = \text{TXD2} = \text{V}_{\text{IO}} \\ \text{STB1} = \text{STB2} = \text{V}_{\text{IO}} \\ \text{R}_{\text{L}} = 60 \ \Omega, \ \text{C}_{\text{L}} = \text{open} \\ \text{See} \ \fbox{7-1} \end{array}$		0.4	2	μΑ



6.6 Supply Characteristics (continued)

Over recommended operating conditions with T_A = -40 $^\circ\!{\rm C}$ to 125 $^\circ\!{\rm C}$ (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
		Dominant One channel ⁽¹⁾	$\label{eq:transformation} \begin{array}{l} TXDx = 0 \; V \; \& \; TXDy = V_{IO} \; {}^{(2)} \\ STB1 = \; STB2 = 5 \; V \\ RXD \; floating \end{array}$		150	348	μΑ
	IO supply current normal mode	Dominant Two channels	TXD1 = TXD2 = 0 V STB1 = STB2 = 5 V RXD floating		255	600	μA
IIO		Recessive Two channels	TXD1 = TXD2 = V _{IO} STB1 = STB2 = 5 V RXD floating		50	96	μΑ
	IO supply current standby mode S		$\label{eq:states} \begin{array}{l} TXD1 = TXD2 = V_{IO} \\ STB1 = STB2 = V_{IO} \\ RXD1 = RXD2 = floating \end{array}$		17	27	μΑ
UV _{VCC}	Rising under voltage detect	ion on V _{CC} for prote	n V _{CC} for protected mode		4.2	4.4	V
UV _{VCC}	Falling under voltage detect	tion on V _{CC} for prot	n V _{CC} for protected mode		4	4.25	V
UV _{VIO}	Rising under voltage detect	tection on V _{IO}			1.56	1.65	V
UV _{VIO}	Falling under voltage detect	tion on V _{IO}		1.4	1.51	1.59	V

(1) TXD1 and TXD2 are interchangeable for TXDx and TXDy

(2) CAN1 and CAN2 are interchangeable for CANx and CANy

6.7 Dissipation Ratings

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
P _D	Average power dissipation one channel Normal mode	V_{CC} = 5 V, V_{IO} = 1.8 V, T_J = 27°C, R_L = 60 Ω , TXD input = 250 kHz 50% duty cycle square wave, C_{L_RXD} = 15 pF		130		mW
P _D	Average power dissipation one channel Normal mode	V_{CC} = 5 V, V_{IO} = 3.3 V, T_J = 27°C, R_L = 60 Ω , TXD input = 250 kHz 50% duty cycle square wave, C_{L_RXD} = 15 pF		130		mW
P _D	Average power dissipation one channel Normal mode	V_{CC} = 5 V, V_{IO} = 5 V, T_J = 27°C, R_L = 60 Ω , TXD input = 250 kHz 50% duty cycle square wave, C_{L_RXD} = 15 pF		130		mW
P _D	Average power dissipation one channel Normal mode	$\label{eq:V_CC} \begin{array}{l} V_{CC}=5.5 \ V, \ V_{IO}=1.8 \ V, \ T_J=150^\circ C, \ R_L=60 \ \Omega, \\ TXD \ input=2.5 \ MHz \ 50\% \ duty \ cycle \ square \\ wave, \ C_{L_RXD}=15 \ pF \end{array}$		140		mW
P _D	Average power dissipation one channel Normal mode	V_{CC} = 5.5 V, V_{IO} = 3.3 V, T_J = 150°C, R_L = 60 Ω , TXD input = 2.5 MHz 50% duty cycle square wave, C_{L_RXD} = 15 pF		140		mW
P _D	Average power dissipation one channel Normal mode	V_{CC} = 5.5 V, V_{IO} = 5 V, T_J= 150°C, R_L = 60 Ω , TXD input = 2.5 MHz 50% duty cycle square wave, C_{L_RXD} = 15 pF		140		mW
T _{TSD}	Thermal shutdown temperature			192		°C
T _{TSD_HYS}	Thermal shutdown hysteresis			10		C



6.8 Electrical Characteristics

Over recommended operating conditions with $T_A = -40^{\circ}$ to 125° (unless otherwise noted); CAN electrical parameters apply to both channels

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	
Driver Electi	rical Characteristics						
		CANH	TXD = 0 V, STB = 0 V, 50 $\Omega \leq R_L \leq 65$	2.75		4.5	V
V _{O(DOM)}	Dominant output voltage Normal mode	CANL	Ω, C _L = open, R _{CM} = open See 图 7-2 and 图 8-3,	0.5		2.25	v
V _{O(REC)}	Recessive output voltage Normal mode	CANH and CANL	$\label{eq:transform} \begin{array}{l} TXD = V_{IO}, STB = 0 V, R_{L} = open (no load), R_{CM} = open See \mathbb{N} 7-2 and \mathbb{N} 8-3 \end{array}$	2	0.5 V _{CC}	3	v
V _{SYM}	Driver symmetry (V _{O(CANH)} + V _{O(CANL)})/V _{CC}		$\begin{array}{l} \text{STB = 0 V, R_L = 60 } \Omega, \ \text{C}_{\text{SPLIT}} = 4.7 \ \text{nF, } \text{C}_L \\ = \ \text{open, } \text{R}_{\text{CM}} = \ \text{open, } \text{TXD} = 250 \ \text{kHz}, \ 1 \\ \text{MHz, } 2.5 \ \text{MHz} \\ \text{See } \ \ensuremath{\mathbb{S}} \ 7-2 \ \text{and} \ \ensuremath{\mathbb{S}} \ 9-2 \end{array}$	0.9		1.1	VA
V _{SYM_DC}	DC output symmetry (V _{CC} - V _{O(CANH)} - V _{O(CANL)})		STB = 0 V, R _L = 60 Ω, C _L = open See 🕅 7-2 and 🕅 8-3	- 400		400	m۱
			$\label{eq:states} \begin{array}{l} TXD = 0 \; V, \; STB = 0 \; V, \; 50 \; \Omega \leqslant R_{L} \leqslant 65 \\ \Omega, \; C_{L} = open \\ See \; \; S \; 7-2 \; and \; \; \; \texttt{S} \; 8-3 \end{array}$	1.5		3	v
V _{OD(DOM)}	Differential output voltage Normal mode Dominant	CANH - CANL	$\label{eq:transform} \begin{array}{c} TXD = 0 \; V, STB = 0 \; V, 45 \; \Omega \leqslant R_L \leqslant 70 \\ \Omega, \; C_L = open \\ See \; \boxtimes \; 7-2 \; and \; \boxtimes \; 8-3 \end{array}$	1.4		3.3	v
			TXD = 0 V, STB = 0 V, R _L = 2240 Ω, C _L = open see	1.5		5	v
V _{OD(REC)}	Differential output voltage Normal mode Recessive	CANH - CANL	TXD = V _{IO} , STB = 0 V, R _L = 60 Ω , C _L = openSee 🖾 7-2 and 🖾 8-3	- 120		12	m∖
			TXD = V_{IO} , STB = 0 V, R_L = open, C_L = openSee $\[M]$ 7-2 and $\[M]$ 8-3	- 50		50	m۱
	Bus output voltage Standby mode	CANH		-0.1		0.1	V
V _{O(STB)}			STB = V _{IO} , R _L = open (no load)	-0.1		0.1	V
	CANH - CANL			-0.2		0.2	V
100/00 DOW	Short-circuit steady-state ou dominant	tput current,	STB = 0 V, V _(CANH) = -15 V to 40 V, CANL = open, TXD = 0 V See	- 115			mA
IOS(SS_DOM)	Normal mode		$ \begin{array}{l} STB = 0 \ V, \ V_{(CAN\ L)} = -15 \ V \ to \ 40 \ V, \ CANH \\ = \ open, \ TXD = 0 \ \overline{V} \\ See \ \begin{tabular}{l} See \ \begin{tabular} \begin{tabular}{l} See \ tab$			115	mA
I _{OS(SS_REC)}	Short-circuit steady-state ou recessive Normal mode	tput current,	$\begin{array}{l} \text{STB = 0 V, } -27 \ V \leqslant V_{BUS} \leqslant 32 \ V, \ \text{where} \\ \text{V}_{BUS} = \text{CANH} = \text{CANL}, \ \text{TXD} = \text{V}_{IO} \\ \text{See $\begin{subarray}{c} \$ \ 7-7 \ \text{and} $\begin{subarray}{c} \$ \ 8-3 \end{subarray} \end{array} \end{array}$	- 5		5	mA
Receiver Ele	ectrical Characteristics		· ·				
V _{IT}	Input threshold voltage Normal mode		STB = 0 V, -12 V ≤ V_{CM} ≤ 12 V See 图 7-3, 表 7-1, and 表 8-5	500		900	m∿
V _{IT(STB)}	Input threshold Standby mode		STB = V _{IO} , -12 V ≤ V _{CM} ≤ 12 V See 图 7-3, 表 7-1, and 表 8-5	400		1150	m\
V _{DOM}	Dominant state differential ir Normal mode	nput voltage range	STB = 0 V, -12 V ≤ V _{CM} ≤ 12 V See 图 7-3, 表 7-1, and 表 8-5	0.9		9	v
V _{REC}	Recessive state differential input voltage range Normal mode		STB = 0 V, -12 V ≤ V _{CM} ≤ 12 V See 图 7-3, 表 7-1, and 表 8-5	-4		0.5	V
V _{DOM(STB)}	Dominant state differential ir Standby mode	nput voltage range	$\begin{array}{l} {\rm STB} = {\rm V}_{\rm IO}, \text{-12 V} \leqslant {\rm V}_{\rm CM} \leqslant \text{12 V} \\ {\rm See} \ \textcircled{B} \ \text{7-3}, \ \fbox{7-1}, \ \text{and} \ \v{5} \text{8-5} \end{array}$	1.15		9	v
V _{REC(STB)}	Recessive state differential i Standby mode	nput voltage range	$\begin{array}{l} {\rm STB} = {\rm V}_{\rm IO}, \text{-12 V} \leqslant {\rm V}_{\rm CM} \leqslant \text{12 V} \\ {\rm See} \ \textcircled{B} \ \text{7-3}, \ \fbox{7-1}, \ \text{and} \ \v{5} \text{8-5} \end{array}$	-4		0.4	v
V _{HYS}	Hysteresis voltage for input	threshold	STB = 0 V, -12 V ≤ V _{CM} ≤ 12 V See 图 7-3, 表 7-1, and 表 8-5		100		m\



6.8 Electrical Characteristics (continued)

Over recommended operating conditions with T_A = -40 $^\circ\!\!\mathbb{C}$ to 125 $^\circ\!\!\mathbb{C}$ (unless otherwise noted); CAN electrical parameters apply to both channels

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{CM}	Common mode range Normal and standby modes	See 图 7-3 and 表 8-5 表 8-5	- 12		12	V
I _{LKG(IOFF)}	Unpowered bus input leakage current	CANH = CANL = 5 V, V _{CC} = V _{IO} = GND			5	μA
CI	Input capacitance to ground (CANH or CANL)	$-TXD = V_{10}^{(1)}$			20	pF
CID	Differential input capacitance	$-1XD = V_{10}$			10	pF
R _{ID}	Differential input resistance	$-$ TXD = V _{IO} ⁽¹⁾ , STB = 0 V, -12 V \leq V _{CM} \leq	40		90	kΩ
R _{IN}	Single ended input resistance (CANH or CANL)	$\begin{array}{c} 1 \text{ XD} = V_{10} \text{ (°)}, \text{ STB} = 0 \text{ (°)}, -12 \text{ (°)} $	20		45	kΩ
TXD Termin	nal (CAN Transmit Data Input)	1				
V _{IH}	High-level input voltage		0.7 V _{IO}			V
V _{IL}	Low-level input voltage				0.3 V _{IO}	V
I _{IH}	High-level input leakage current	$TXD = V_{CC} = V_{IO} = 5.5 V$	- 2.5	0	1	μA
IIL	Low-level input leakage current	TXD = 0 V, V _{CC} = V _{IO} = 5.5 V	- 200	-100	- 20	μA
I _{LKG(OFF)}	Unpowered leakage current	TXD = 5.5 V, V _{CC} = V _{IO} = 0 V	- 1	0	1	μA
RXD Termi	nal (CAN Receive Data Output)	1				L
V _{OH}	High-level output voltage	I _O = − 2 mA, See <u>⊠</u> 7-3	0.8 V _{IO}			V
V _{OL}	Low-level output voltage	I _O = − 2 mA, See <u>⊠</u> 7-3			0.2 V _{IO}	V
STB Termin	nal (Standby Mode Input)	1I				
VIH	High-level input voltage		0.7 V _{IO}			V
VIL	Low-level input voltage				0.3 V _{IO}	V
I _{IH}	High-level input leakage current	V _{CC} = V _{IO} = STB = 5.5 V	- 2		2	μA
IIL	Low-level input leakage current	V _{CC} = V _{IO} = 5.5 V, STB = 0 V	- 20		- 2	μA
I _{LKG(OFF)}	Unpowered leakage current	STB = 5.5V, V _{CC} = V _{IO} = 0 V	- 1	0	1	μA

(1) $V_{IO} = V_{CC}$ in non-V variants of device

6.9 Switching Characteristics

Over recommended operating conditions with $T_A = -40^{\circ}$ to 125° (unless otherwise noted); Timing parameters apply to both CAN channels

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
Device Switchin	evice Switching Characteristics							
t _{PROP(LOOP1)}	Total loop delay, driver input (TXD) to receiver output (RXD), recessive to dominant	Normal mode, $R_L = 60 \Omega$, $C_L = 100 \text{ pF}$, $C_{L(RXD)} = 15 \text{ pF}$ $V_{IO} = 2.8 \text{ V to } 5.5 \text{ V}$ See 🛐 7-4		125	210	ns		
t _{PROP(LOOP1)}	Total loop delay, driver input (TXD) to receiver output (RXD), recessive to dominant	Normal mode, $R_L = 60 \Omega$, $C_L = 100 pF$, $C_{L(RXD)} = 15 pF$ $V_{IO} = 1.7 V$ See 😫 7-4		165	255	ns		
tprop(loop2)	Total loop delay, driver input (TXD) to receiver output (RXD), dominant to recessive	Normal mode, $R_L = 60 \Omega$, $C_L = 100 pF$, $C_{L(RXD)} = 15 pF$ $V_{IO} = 2.8 V to 5.5 V$ See 😫 7-4		150	210	ns		
tprop(LOOP2)	Total loop delay, driver input (TXD) to receiver output (RXD), dominant to recessive	Normal mode, $R_L = 60 \Omega$, $C_L = 100 pF$, $C_{L(RXD)} = 15 pF$ $V_{IO} = 1.7 V$ See 😫 7-4		180	255	ns		
t _{MODE}	Mode change time, from normal to standby or from standby to normal	See 图 7-5			20	μs		
t _{WK_FILTER}	Filter time for a valid wake-up pattern	See 图 8-5	0.5		1.8	μs		
t _{WK_TIMEOUT}	Bus wake-up timeout	See 图 8-5	0.8		6	ms		

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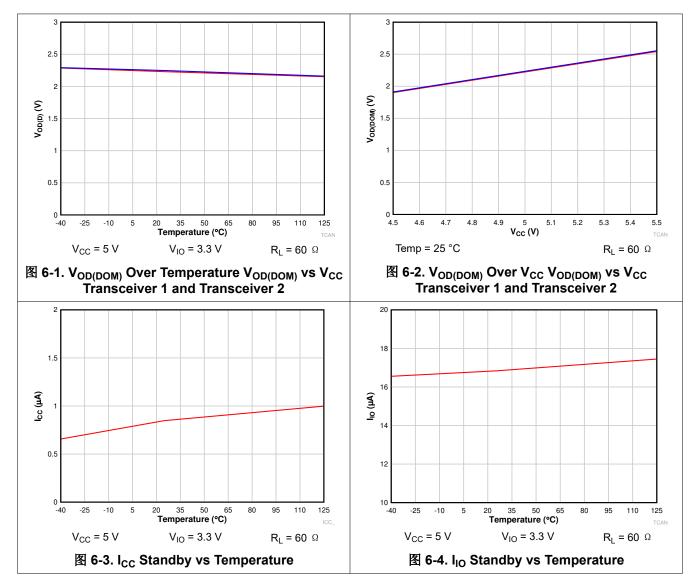
6.9 Switching Characteristics (continued)

Over recommended operating conditions with T_A = -40 $^\circ\!\!\mathbb{C}$ to 125 $^\circ\!\!\mathbb{C}$ (unless otherwise noted); Timing parameters apply to both CAN channels

	PARAMETER	TEST CONDITIONS	MIN T	YP MAX	UNIT
Driver Switch	ing Characteristics				
t _{pHR}	Propagation delay time, high TXD to driver recessive (dominant to recessive)			80	ns
t _{pLD}	Propagation delay time, low TXD to driver dominant (recessive to dominant)	- STB = 0 V, R ₁ = 60 Ω, C ₁ = 100 pF		70	ns
t _{sk(p)}	Pulse skew (tpHR - tpLD)	See 图 7-2 and 图 7-6		20	ns
t _R	Differential output signal rise time			30	ns
t _F	Differential output signal fall time			50	ns
t _{TXD_DTO}	Dominant timeout		1.2	4.0	ms
Receiver Swit	tching Characteristics				
t _{pRH}	Propagation delay time, bus recessive input to high output (dominant to recessive)			90	ns
t _{pDL}	Propagation delay time, bus dominant input to low output (recessive to dominant)	STB = 0 V, C _{L(RXD)} = 15 pF See		65	ns
t _R	RXD output signal rise time			10	ns
t _F	RXD output signal fall time			10	ns
FD Timing Ch	aracteristics		·		
t _{BIT(BUS)}	Bit time on CAN bus output pins t _{BIT(TXD)} = 500 ns		450	530	ns
t _{BIT(BUS)}	Bit time on CAN bus output pins t _{BIT(TXD)} = 200 ns		155	210	ns
t _{BIT(RXD)}	Bit time on RXD output pins t _{BIT(TXD)} = 500 ns	STB = 0 V, R _L = 60 Ω, C _L = 100 pF, C _{L(RXD)} = 15 pF	400	550	ns
t _{BIT(RXD)}	Bit time on RXD output pins t _{BIT(TXD)} = 200 ns	$\Delta t_{REC} = t_{BIT(RXD)} - t_{BIT(BUS)}$ See [A] 7-4	120	220	ns
t _{REC}	Receiver timing symmetry t _{BIT(TXD)} = 500 ns		-50	20	ns
t _{REC}	Receiver timing symmetry t _{BIT(TXD)} = 200 ns		-45	15	ns



6.10 Typical Characteristics





7 Parameter Measurement Information

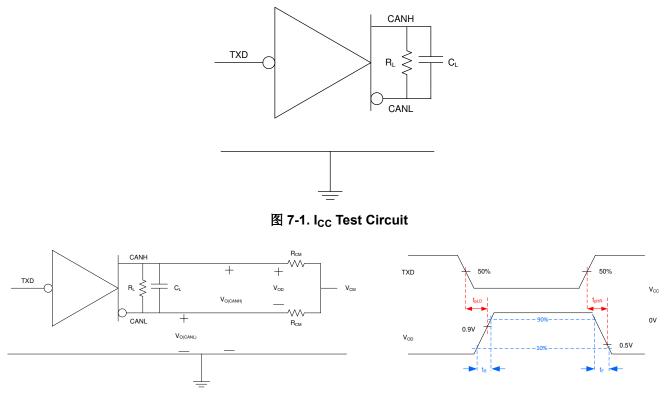


图 7-2. Driver Test Circuit and Measurement

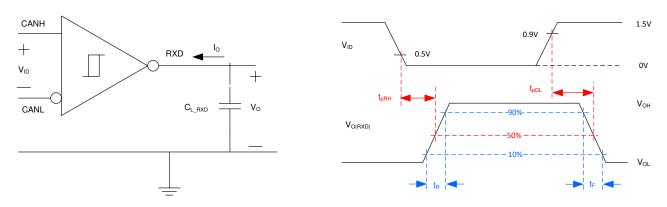








表 7-1. Receiver Differential Input Voltage Threshold Test								
	Input (See 图 7-3)		Out	put				
V _{CANH}	V _{CANL}	V _{ID}	RX	D				
-11.5 V	-12.5 V	1000 mV						
12.5 V	11.5 V	1000 mV	Low	N/				
-8.55 V	-9.45 V	900 mV	Low	V _{OL}				
9.45 V	8.55 V	900 mV						
-8.75 V	-9.25 V	500 mV						
9.25 V	8.75 V	500 mV						
-11.8 V	-12.2 V	400 mV	High	V _{OH}				
12.2 V	11.8 V	400 mV						
Open	Open	X						

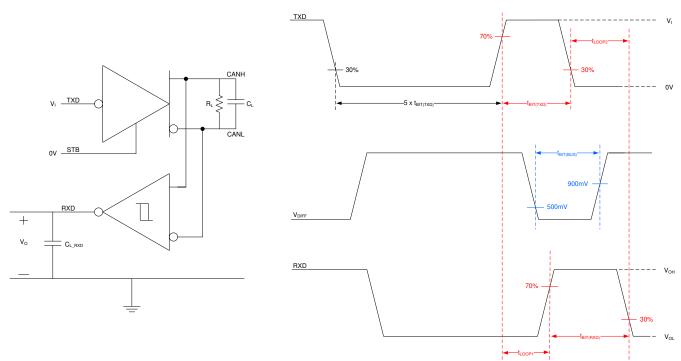


图 7-4. Transmitter and Receiver Timing Test Circuit and Measurement



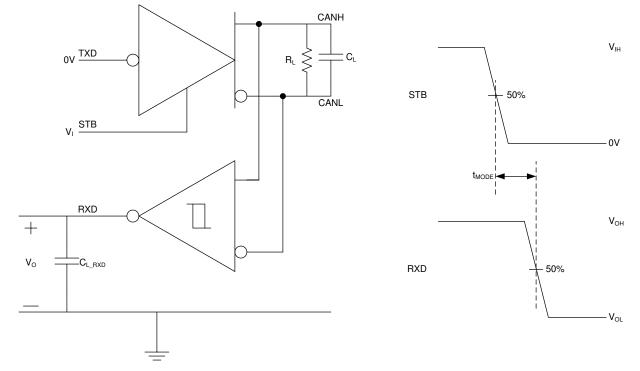
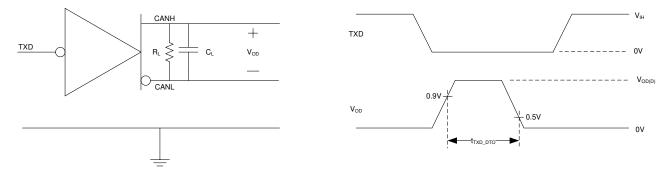
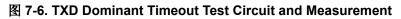
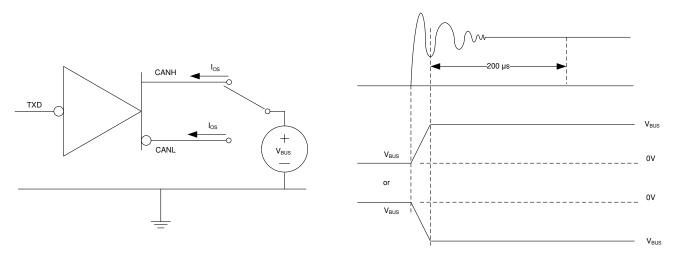
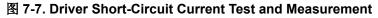


图 7-5. TCAN1046V-Q1 t_{MODE} Test Circuit and Measurement











8 Detailed Description

8.1 Overview

The TCAN1046V-Q1 meets or exceeds the specifications of the ISO 11898-2:2016 high speed CAN (Controller Area Network) physical layer standard. The device has been certified to the requirements of ISO 11898-2:2016 and ISO 11898-5:2007 physical layer requirements according to the GIFT/ICT high speed CAN test specification. The transceiver provides a number of different protection features making it ideal for the stringent automotive system requirements while also supporting CAN FD data rates up to 8 Mbps.

The TCAN1046V-Q1 conforms to the following CAN standards:

- CAN transceiver physical layer standards:
 - ISO 11898-2:2016 High speed medium access unit
 - ISO 11898-5:2007 High speed medium access unit with low-power mode
 - SAE J2284-1: High Speed CAN (HSC) for Vehicle Applications at 125 kbps
 - SAE J2284-2: High Speed CAN (HSC) for Vehicle Applications at 250 kbps
 - SAE J2284-3: High Speed CAN (HSC) for Vehicle Applications at 500 kbps
 - SAE J2284-4: High-Speed CAN (HSC) for Vehicle Applications at 500 kbps with CAN FD Data at 2 Mbps
 - SAE J2284-5: High-Speed CAN (HSC) for Vehicle Applications at 500 kbps with CAN FD Data at 5 Mbps
 - ARINC 825-4 General Standardization of CAN (Controller Area Network) Bus Protocol For Airborne Use
- Conformance test requirements:
 - ISO 16845-2 Road vehicles Controller area network (CAN) conformance test plan Part 2: High-speed medium access unit conformance test plan



8.2 Functional Block Diagram

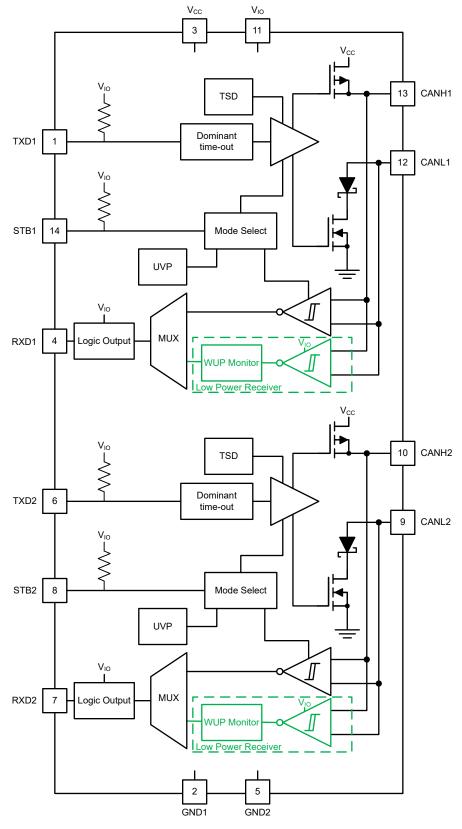


图 8-1. Block Diagram



8.3 Feature Description

8.3.1 Pin Description

8.3.1.1 TXD1 and TXD2

TXD1 and TXD2 are the logic-level signals, referenced to either V_{CC} or V_{IO} , from a CAN controller to the device.

8.3.1.2 GND1 and GND2

GND1 and GND2 are ground pins of the transceiver, both must be connected to the PCB ground.

8.3.1.3 V_{CC}

 V_{CC} provides the 5-V power supply to the CAN transceiver.

8.3.1.4 RXD1 and RXD2

RXD1 and RXD2 are the logic-level signals, referenced to V_{IO} , from the TCAN1046V-Q1 to a CAN controller. This pin is only driven once V_{IO} is present.

8.3.1.5 V_{IO}

The V_{IO} pin provides the digital I/O voltage to match the CAN controller voltage thus avoiding the requirement for a level shifter. It supports voltages from 1.7 V to 5.5 V providing the widest range of controller support.

8.3.1.6 CANH and CANL

These are the CAN high and CAN low differential bus pins. These pins are connected to the CAN transceiver and the low-voltage WUP CAN receiver.

8.3.1.7 STB1 and STB2 (Standby)

The STB1 and STB2 pins are input pins used for mode control of the transceiver.

The TCAN1046V-Q1 implements STB1 and STB2 which can be supplied from either the system processor or from a static system voltage source. If normal mode is the only intended mode of operation than the STB pins can be tied directly to GND.

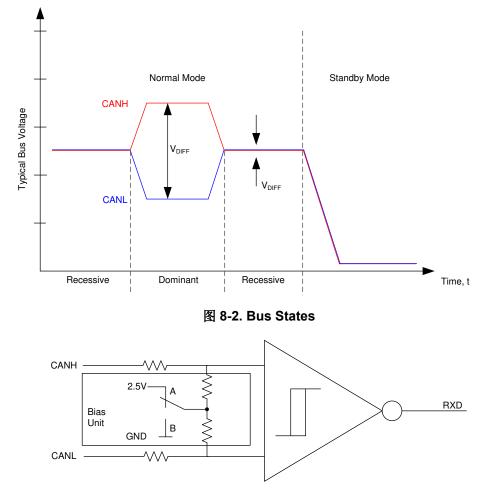
8.3.2 CAN Bus States

The CAN bus has two logical states during operation: recessive and dominant. See 8 8-2 and 8 8-3.

A dominant bus state occurs when the bus is driven differentially and corresponds to a logic low on the TXD1, TXD2, RXD1 and RXD2 pins. A recessive bus state occurs when the bus is biased to $V_{CC}/2$ via the high-resistance internal input resistors R_{IN}) of the receiver and corresponds to a logic high on the TXD1, TXD2, RXD1 and RXD2 pins.

A dominant state overwrites the recessive state during arbitration. Multiple CAN nodes may be transmitting a dominant bit at the same time during arbitration, and in this case the differential voltage of the bus is greater than the differential voltage of a single driver.

The TCAN1046V-Q1 transceiver implements a low-power standby (STB) mode which enables a third bus state where the bus pins are weakly biased to ground via the high resistance internal resistors of the receiver. See \bigotimes 8-2 and \bigotimes 8-3.



- A. Normal Mode
- B. Standby Mode

图 8-3. Simplified Recessive Common Mode Bias Unit and Receiver

8.3.3 TXD Dominant Timeout (DTO)

During normal mode, the only mode where the CAN driver is active, the TXD DTO circuit prevents the local node from blocking network communication in the event of a hardware or software failure where TXD is held dominant longer than the timeout period t_{TXD_DTO} . The TXD DTO circuit is triggered by a falling edge on TXD. If no rising edge is seen before the timeout period of the circuit, t_{TXD_DTO} , the CAN driver is disabled. This frees the bus for communication between other nodes on the network. The CAN driver is reactivated when a recessive signal is seen on the TXD pin, thus clearing the dominant timeout. The receiver remains active and biased to $V_{CC}/2$ and the RXD output reflects the activity on the CAN bus during the TXD DTO fault.

The minimum dominant TXD time allowed by the TXD DTO circuit limits the minimum possible transmitted data rate of the device. The CAN protocol allows a maximum of eleven successive dominant bits (on TXD) for the worst case, where five successive dominant bits are followed immediately by an error frame. The minimum transmitted data rate may be calculated using \overline{f} \overline{f} \overline{f} 1.

Minimum Data Rate = 11 bits / $t_{TXD DTO}$ = 11 bits / 1.2 ms = 9.2 kbps

(1)

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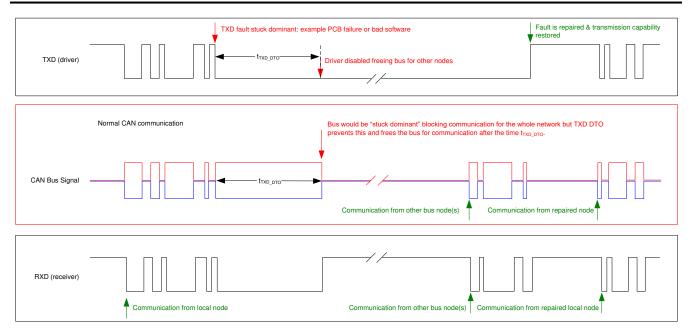


图 8-4. Example Timing Diagram for TXD Dominant Timeout

8.3.4 CAN Bus Short Circuit Current Limiting

The TCAN1046V-Q1 has several protection features that limit the short circuit current when a CAN bus line is shorted. These include CAN driver current limiting in the dominant and recessive states and TXD dominant state timeout which prevents permanently having the higher short circuit current of a dominant state in case of a system fault. During CAN communication the bus switches between the dominant and recessive states, thus the short circuit current may be viewed as either the current during each bus state or as a DC average current. When selecting termination resistors or a common mode choke for the CAN design the average power rating, $I_{OS(AVG)}$, should be used. The percentage dominant is limited by the TXD DTO and the CAN protocol which has forced state changes and recessive bits due to bit stuffing, control fields, and interframe space. These ensure there is a minimum amount of recessive time on the bus even if the data field contains a high percentage of dominant bits.

The average short circuit current of the bus depends on the ratio of recessive to dominant bits and their respective short circuit currents. The average short circuit current may be calculated using 5程式 2.

 $I_{OS(AVG)} = \% \text{ Transmit } x \left[(\% \text{ REC}_{Bits } x I_{OS(SS) REC}) + (\% \text{ DOM}_{Bits } x I_{OS(SS) DOM}) \right] + \left[\% \text{ Receive } x I_{OS(SS) REC} \right] (2)$

Where:

- I_{OS(AVG)} is the average short circuit current
- % Transmit is the percentage the node is transmitting CAN messages
- % Receive is the percentage the node is receiving CAN messages
- % REC_Bits is the percentage of recessive bits in the transmitted CAN messages
- % DOM_Bits is the percentage of dominant bits in the transmitted CAN messages
- · IOS(SS) REC is the recessive steady state short circuit current
- I_{OS(SS) DOM} is the dominant steady state short circuit current

This short circuit current and the possible fault cases of the network should be taken into consideration when sizing the power supply used to generate the transceivers V_{CC} supply.

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8.3.5 Thermal Shutdown (TSD)

If the junction temperature of the TCAN1046V-Q1 exceeds the thermal shutdown threshold, T_{TSD} , the device turns off the CAN driver circuitry and blocks the TXD to bus transmission path. The shutdown condition is cleared when the junction temperature of the device drops below T_{TSD} . The CAN bus pins are biased to $V_{CC}/2$ during a TSD fault and the receiver to RXD path remains operational. The TCAN1046V-Q1 TSD circuit includes hysteresis which prevents the CAN driver output from oscillating during a TSD fault.

8.3.6 Undervoltage Lockout

The supply pins, V_{CC} and V_{IO} , have undervoltage detection that places the device into a protected state. This protects the bus during an undervoltage event on either supply pin.

V _{cc}	V _{IO}	DEVICE STATE	BUS	RXD PIN
> UV _{VCC}	> UV _{VIO}	Normal	Per TXD	Mirrors bus
	> UV _{VIO}	STB = V _{IO} : Standby mode		V _{IO} : Remote wake request ⁽²⁾
< UV _{VCC}	2 0 V VIO	STB = GND: Protected mode	High impedance Weak pull-down to	Recessive
> UV _{VCC}	< UV _{VIO}	Protected	ground ⁽¹⁾	High impedance
< UV _{VCC}	< UV _{VIO}	Protected	-	High impedance

表 8-1. Undervoltage Lockout - TCAN1046V-Q1

(1) $V_{CC} = GND$, see $I_{LKG(OFF)}$

(2) See 节 8.4.3.1

Once the undervoltage condition is cleared and t_{MODE} has expired the TCAN1046V-Q1 transitions to normal mode and the host controller can send and receive CAN traffic again.

8.3.7 Unpowered Device

The TCAN1046V-Q1 is designed to be an ideal passive or no load to the CAN bus if the device is unpowered. The bus pins were designed to have low leakage currents when the device is unpowered, so they do not load the bus. This is critical if some nodes of the network are unpowered while the rest of the of network remains operational.

The logic pins also have low leakage currents when the device is unpowered, so they do not load other circuits which may remain powered.

8.3.8 Floating pins

The TCAN1046V-Q1 has internal pull-ups or pull-downs on critical pins which place the device into known states if the pin floats. This internal bias should not be relied upon by design though, especially in noisy environments, but instead should be considered a failsafe protection feature.

When a CAN controller supporting open-drain outputs is used an adequate external pull-up resistor must be chosen. This ensures that the TXD output of the CAN controller maintains acceptable bit time to the input of the CAN transceiver. See $\frac{1}{8}$ 8-2 for details on pin bias conditions.

Pin Pull-up or Pull-down		Comment						
TXD1 and TXD2	Pull-up	Weakly biases TXD1 and TXD2 towards recessive to prevent bus blockage or TXD DTO triggering						
STB1 and STB2	PUII-UD	Weakly biases STB1 and STB2 towards low-power standby mode to prevent excessive system power						

表 8-2.	Pin	Bias
--------	-----	------

8.4 Device Functional Modes

8.4.1 Operating Modes

The TCAN1046V-Q1 has two main operating modes; normal mode and standby mode. Operating mode selection is made by applying a high or low level to the STB pin on the device.



表 8-3. Operating Modes											
STB	Device Mode	Driver	RXD Pin								
High	Standby mode	Disabled	Low-power receiver with bus monitor enable	High (recessive) until valid WUP is received See section 8.3.3.1							
Low	Normal Mode	Enabled	Enabled	Mirrors bus state							

8.4.2 Normal Mode

This is the normal operating mode of the TCAN1046V-Q1. The CAN driver and receiver are fully operational and CAN communication is bi-directional. The driver is translating a digital input on the TXD1 and TXD2 inputs to a differential output on the CANH1, CANL1 and CANH2, CANL2 bus pins. The receiver is translating the differential signal from CANH1, CANL1 and CANH2, CANL2 to a digital output on the RXD1 and RXD2 outputs.

8.4.3 Standby Mode

This is the low-power mode of the TCAN1046V-Q1. The CAN driver and main receiver are switched off and bidirectional CAN communication is not possible. The low-power receiver and bus monitor circuits are enabled to allow for RXD wake-up requests via the CAN bus. A wake-up request is output to RXD1 or RXD2 depending on the channel which received the WUP as shown in 🕅 8-5. The local CAN protocol controller should monitor RXD1 and RXD2 for transitions (high-to-low) and reactivate the device to normal mode by pulling the STB1 and STB2 pin low. The CAN bus pins are weakly pulled to GND in this mode; see 🕅 8-2 and 🕅 8-3.

In standby mode, only the V_{IO} supply is required therefore the V_{CC} may be switched off for additional system level current savings.

8.4.3.1 Remote Wake Request via Wake-Up Pattern (WUP) in Standby Mode

The TCAN1046V-Q1 supports a remote wake-up request that is used to indicate to the host controller that the bus is active and the node should return to normal operation.

The device uses the multiple filtered dominant wake-up pattern (WUP) from the ISO 11898-2:2016 standard to qualify bus activity. Once a valid WUP has been received, the wake request is indicated to the controller by a falling edge and low period corresponding to a filtered dominant on the RXD1 or RXD2 output of the TCAN1046V-Q1.

The WUP consists of a filtered dominant pulse, followed by a filtered recessive pulse, and finally by a second filtered dominant pulse. The first filtered dominant initiates the WUP, and the bus monitor then waits on a filtered recessive; other bus traffic does not reset the bus monitor. Once a filtered recessive is received the bus monitor is waiting for a filtered dominant and again, other bus traffic does not reset the bus monitor. Immediately upon reception of the second filtered dominant the bus monitor recognizes the WUP and drives the RXD1 or RXD2 output low every time an additional filtered dominant signal is received from the bus.

For a dominant or recessive to be considered filtered, the bus must be in that state for more than the t_{WK_FILTER} time. Due to variability in t_{WK_FILTER} the following scenarios are applicable. Bus state times less than $t_{WK_FILTER(MIN)}$ are never detected as part of a WUP and thus no wake request is generated. Bus state times between $t_{WK_FILTER(MIN)}$ and $t_{WK_FILTER(MAX)}$ may be detected as part of a WUP and a wake-up request may be generated. Bus state times greater than $t_{WK_FILTER(MAX)}$ are always detected as part of a WUP, and thus a wake request is always generated. See \mathbb{K} 8-5 for the timing diagram of the wake-up pattern.

The pattern and t_{WK_FILTER} time used for the WUP prevents noise and bus stuck dominant faults from causing false wake-up requests while allowing any valid message to initiate a wake-up request.

The ISO 11898-2:2016 standard has defined times for a short and long wake-up filter time. The t_{WK_FILTER} timing for the device has been picked to be within the minimum and maximum values of both filter ranges. This timing has been chosen such that a single bit time at 500 kbps, or two back-to-back bit times at 1 Mbps triggers the filter in either bus state. Any CAN frame at 500 kbps or less would contain a valid WUP.

For an additional layer of robustness and to prevent false wake-ups, the device implements a wake-up timeout feature. For a remote wake-up event to successfully occur, the entire WUP must be received within the timeout



value $t \leq t_{WK_TIMEOUT}$. If not, the internal logic is reset and the transceiver remains in its current state without waking up. The full pattern must then be transmitted again, conforming to the constraints mentioned in this section. See $\boxtimes 8-5$ for the timing diagram of the wake-up pattern with wake timeout feature.

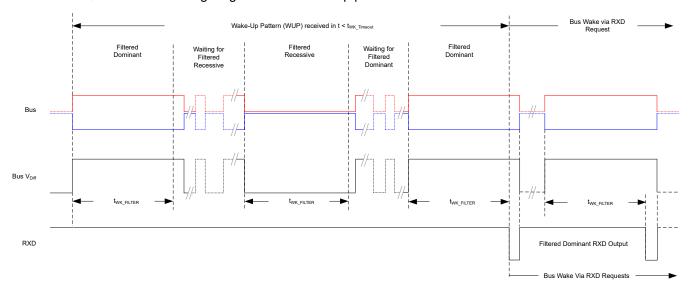


图 8-5. Wake-Up Pattern (WUP) with t_{WK_TIMEOUT}



8.4.4 Driver and Receiver Function

The digital logic input and output levels for the TCAN1046V-Q1 are CMOS levels with respect to V_{IO} for compatibility with protocol controllers having 1.8 V, 2.5 V, 3.3 V, or 5 V I/O levels.

表 8-4. Driver Function Table

Device Mode	TXD Input ⁽¹⁾	Bus	Driven Bus State ⁽²⁾		
Device would	CANH		CANL		
Normal	Low	High	Low	Dominant	
Normai	High or open	High impedance	High impedance	Biased recessive	
Standby	Х	High impedance	High impedance	Biased to ground	

(1) X = irrelevant

(2) For bus state and bias see 8 8-2 and 8 8-3

表 8-5. Receiver Function Table Normal and Standby Mode

Device Mode	CAN Differential Inputs V _{ID} = V _{CANH} - V _{CANL}	Bus State	RXD Pin
	$V_{ID} \ge 0.9 V$	Dominant	Low
Normal	0.5 V < V _{ID} < 0.9 V	Undefined	Undefined
	$V_{ID} \leqslant 0.5 V$	Recessive	High
	$V_{ID} \ge 1.15 V$	Dominant	High
Standby	0.4 V < V _{ID} < 1.15 V	Undefined	Low if a remote wake event occurred
	$V_{ID} \leqslant 0.4 V$	Recessive	See 图 8-5
Any	Open (V _{ID} $pprox$ 0 V)	Open	High



9 Application and Implementation

备注

以下应用部分中的信息不属于 TI 器件规格的范围, TI 不担保其准确性和完整性。TI 的客 户应负责确定器件是否适用于其应用。客户应验证并测试其设计,以确保系统功能。

9.1 Application Information

9.2 Typical Application

The TCAN1046V-Q1 transceiver can be used in applications with a host controller or FPGA that includes the link layer portion of the CAN protocol. [8] 9-1 shows a typical configuration for 5 V controller applications. The bus termination is shown for illustrative purposes.

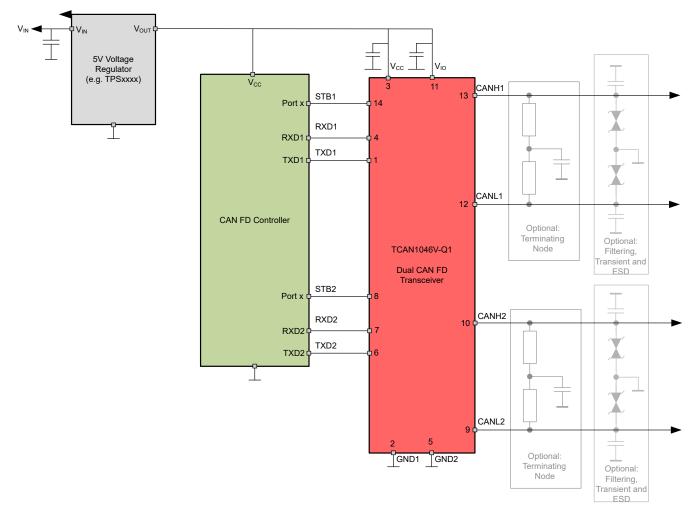


图 9-1. Transceiver Application Using 5 V I/O Connections



9.2.1 Design Requirements

9.2.1.1 CAN Termination

Termination may be a single $120 \cdot \Omega$ resistor at each end of the bus, either on the cable or in a terminating node. If filtering and stabilization of the common-mode voltage of the bus is desired then split termination may be used, see [3] 9-2. Split termination improves the electromagnetic emissions behavior of the network by filtering higher-frequency common-mode noise that may be present on the differential signal lines.

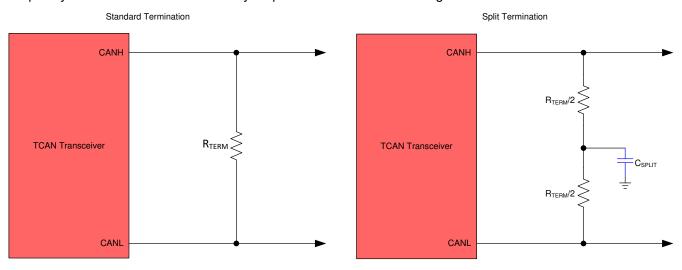


图 9-2. CAN Bus Termination Concepts

9.2.2 Detailed Design Procedures

9.2.2.1 Bus Loading, Length and Number of Nodes

A typical CAN application may have a maximum bus length of 40 meters and maximum stub length of 0.3 m. However, with careful design, users can have longer cables, longer stub lengths, and many more nodes to a bus. A high number of nodes requires a transceiver with high input impedance such as the TCAN1046V-Q1.

Many CAN organizations and standards have scaled the use of CAN for applications outside the original ISO 11898-2 standard. They made system level trade off decisions for data rate, cable length, and parasitic loading of the bus. Examples of these CAN systems level specifications are ARINC 825, CANopen, DeviceNet, SAE J2284, SAE J1939, and NMEA 2000.

A CAN network system design is a series of tradeoffs. In the ISO 11898-2:2016 specification the driver differential output is specified with a bus load that can range from 50 Ω to 65 Ω where the differential output must be greater than 1.5 V. The TCAN1046V-Q1 family is specified to meet the 1.5 V requirement down to 50 Ω and is specified to meet 1.4 V differential output at 45 Ω bus load. The differential input resistance of the TCAN1046V-Q1 is a minimum of 40 k Ω . If 100 TCAN1046V-Q1 transceivers are in parallel on a bus, this is equivalent to a 400- Ω differential load in parallel with the nominal 60 Ω bus termination which gives a total bus load of approximately 52 Ω . Therefore, the TCAN1046V-Q1 family theoretically supports over 100 transceivers on a single bus segment. However, for a CAN network design margin must be given for signal loss across the system and cabling, parasitic loadings, timing, network imbalances, ground offsets and signal integrity thus a practical maximum number of nodes is often lower. Bus length may also be extended beyond 40 meters by careful system design and data rate tradeoffs. For example, CANopen network design guidelines allow the network to be up to 1 km with changes in the termination resistance, cabling, less than 64 nodes and significantly lowered data rate.

This flexibility in CAN network design is one of the key strengths of the various extensions and additional standards that have been built on the original ISO 11898-2 CAN standard. However, when using this flexibility, the CAN network system designer must take the responsibility of good network design to ensure robust network operation.



TCAN1046V-Q1

ZHCSIR6C - SEPTEMBER 2018 - REVISED FEBRUARY 2022

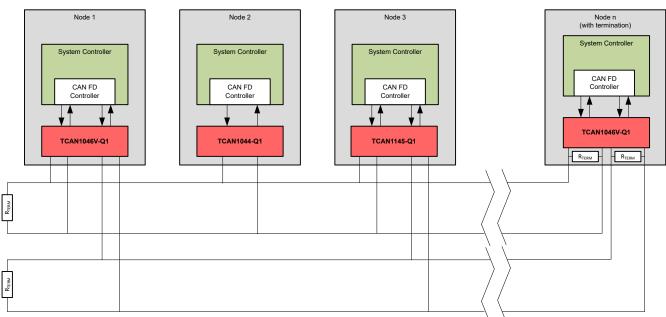
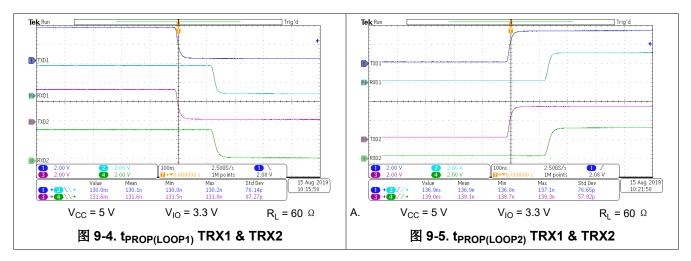


图 9-3. Typical CAN Bus

9.2.3 Application Curves





9.3 System Examples

The TCAN1046V-Q1 CAN transceiver is typically used in applications with a host controller or FPGA that includes the link layer portion of the CAN protocol. A 1.8 V, 2.5 V, or 3.3 V application is shown in \bigotimes 9-6. The bus termination is shown for illustrative purposes.

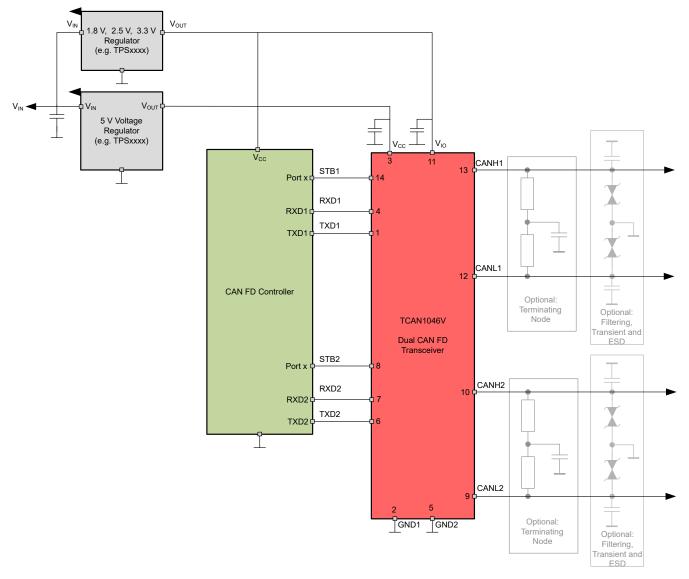


图 9-6. Transceiver Application Using 1.8 V, 2.5 V, 3.3 V I/O Connections

10 Power Supply Recommendations

The TCAN1046V-Q1 device is designed to operate with a main V_{CC} input voltage supply range between 4.5 V and 5.5 V. The device has an IO level shifting supply input, V_{IO}, designed for a range between 1.8 V and 5.5 V. Both supply inputs must be well regulated. A decoupling capacitor, typically 100 nF, should be placed near the CAN transceiver's main V_{CC} and V_{IO} supply pins in addition to bypass capacitors.



11 Layout

Robust and reliable CAN node design may require special layout techniques depending on the application and automotive design requirements. Since transient disturbances have high frequency content and a wide bandwidth, high-frequency layout techniques should be applied during PCB design.

11.1 Layout Guidelines

- Place the protection and filtering circuitry close to the bus connectors, J1 and J2, to prevent transients, ESD, and noise from propagating onto the board. This layout example shows optional transient voltage suppression (TVS) diodes, D1 and D2, which may be implemented if the system-level requirements exceed the specified rating of the transceiver. This example also shows optional bus filter capacitors C6, C8, C9, and C11.
- Design the bus protection components in the direction of the signal path. Do not force the transient current to divert from the signal path to reach the protection device.
- Use at least two vias for supply and ground connections of bypass capacitors and protection devices to minimize trace and via inductance.

备注

High frequency current follows the path of least impedance and not the path of least resistance.

- This layout example shows how split termination could be implemented on the CAN node. The termination is split into two pairs of resistors, R8, R9, R10, and R11, with the center or split tap of the termination connected to ground via capacitors C7 and C10. Split termination provides common mode filtering for the bus. See 节 9.2.1.1, 节 8.3.4, and 方程式 2 for information on termination concepts and power ratings needed for the termination resistor(s).
- To limit current of digital lines series resistors may be used. Examples are R2, R3, R5, R6, R7, and R12.
- Pin 1 and pin 6 are shown for the TXD1 and TXD2 inputs of the device with R1 and R4 as optional pull-up resistors. If an open drain host controller is used this is mandatory to ensure the bit timing into the device is met.
- Pin 8 and 14 are shown assuming the mode pin STB is used. If the device is only used in normal mode then only a pull-down resistor is needed.

11.2 Layout Example

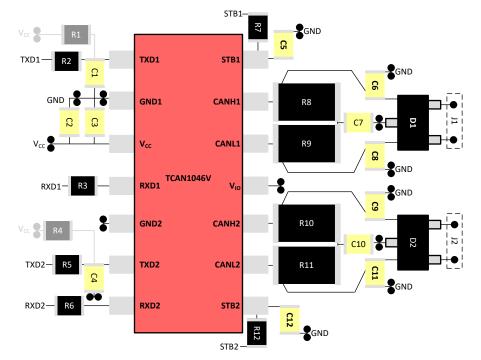


图 11-1. Example Layout



12 Device and Documentation Support

12.1 接收文档更新通知

要接收文档更新通知,请导航至 ti.com 上的器件产品文件夹。点击*订阅更新*进行注册,即可每周接收产品信息更改摘要。有关更改的详细信息,请查看任何已修订文档中包含的修订历史记录。

12.2 支持资源

TI E2E[™] 支持论坛是工程师的重要参考资料,可直接从专家获得快速、经过验证的解答和设计帮助。搜索现有解 答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者"按原样"提供。这些内容并不构成 TI 技术规范,并且不一定反映 TI 的观点;请参阅 TI 的《使用条款》。

12.3 Trademarks

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12.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.5 术语表

TI 术语表 本术语表列出并解释了术语、首字母缩略词和定义。

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	e Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TCAN1046VDMTRQ1	ACTIVE	VSON	DMT	14	3000	RoHS & Green	NIPDAU SN	Level-2-260C-1 YEAR	-40 to 125	1046V	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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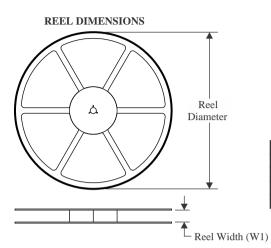
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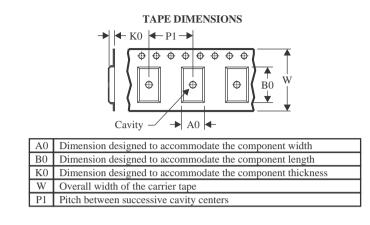


TEXAS

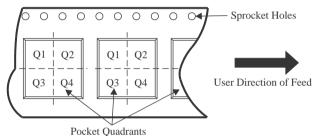
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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



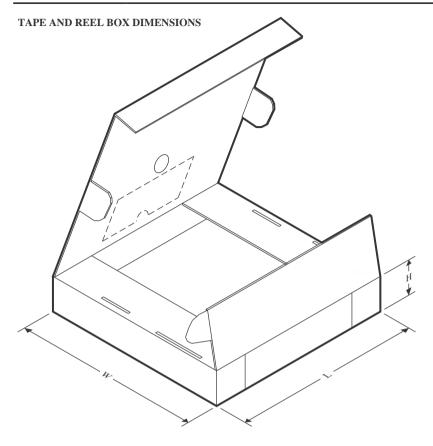
*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TCAN1046VDMTRQ1	VSON	DMT	14	3000	330.0	12.4	3.3	4.8	1.2	8.0	12.0	Q1



www.ti.com

PACKAGE MATERIALS INFORMATION

3-Jun-2022



*All	dimensions	are	nominal	
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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TCAN1046VDMTRQ1	VSON	DMT	14	3000	367.0	367.0	35.0

DMT 14

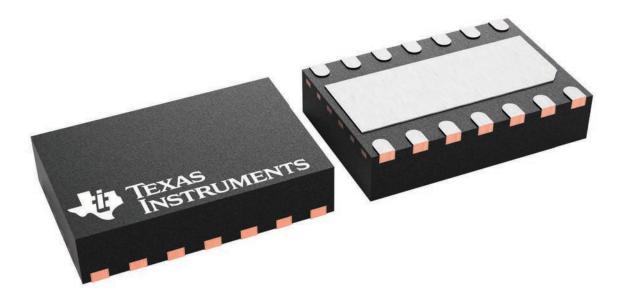
3 x 4.5, 0.65 mm pitch

GENERIC PACKAGE VIEW

VSON - 0.9 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





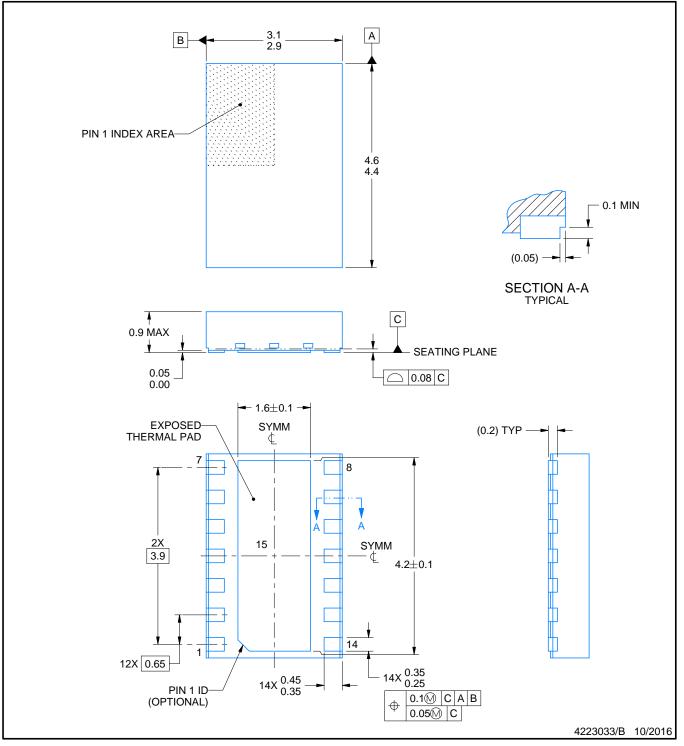
DMT0014A



PACKAGE OUTLINE

VSON - 0.9 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.2. This drawing is subject to change without notice.3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

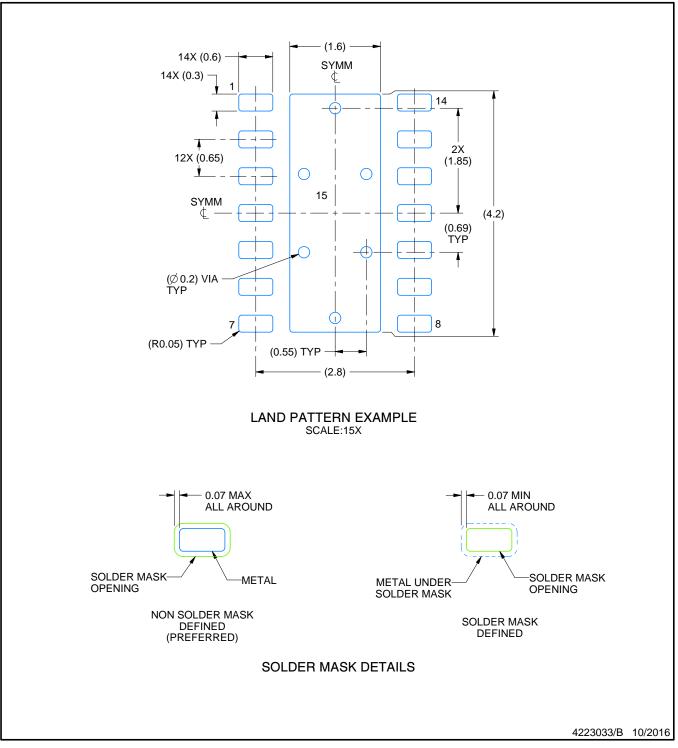


DMT0014A

EXAMPLE BOARD LAYOUT

VSON - 0.9 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

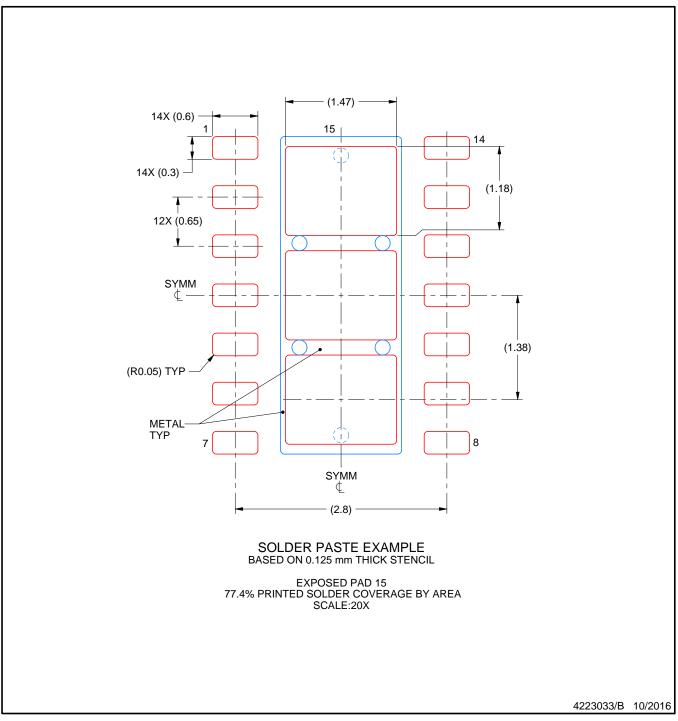


DMT0014A

EXAMPLE STENCIL DESIGN

VSON - 0.9 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



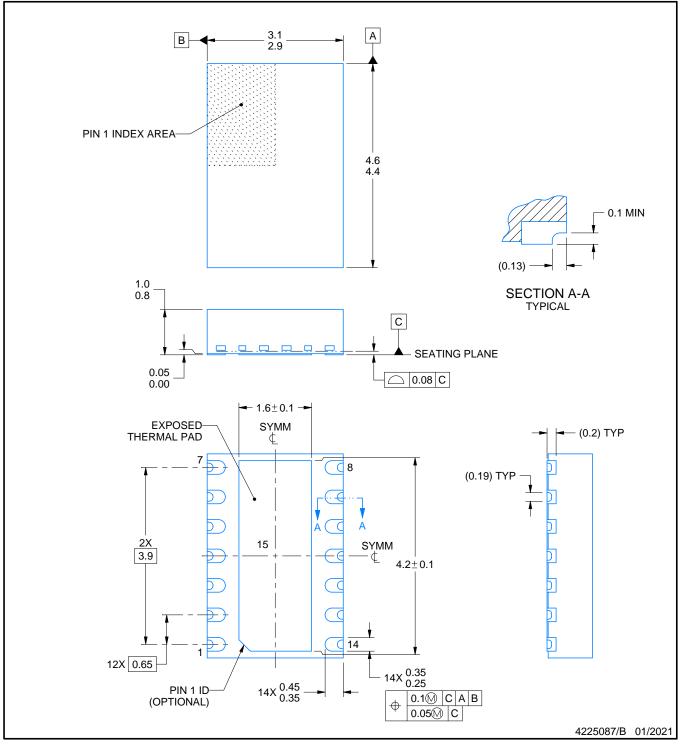
DMT0014B



PACKAGE OUTLINE

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing 2. This drawing is subject to change without notice.
 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

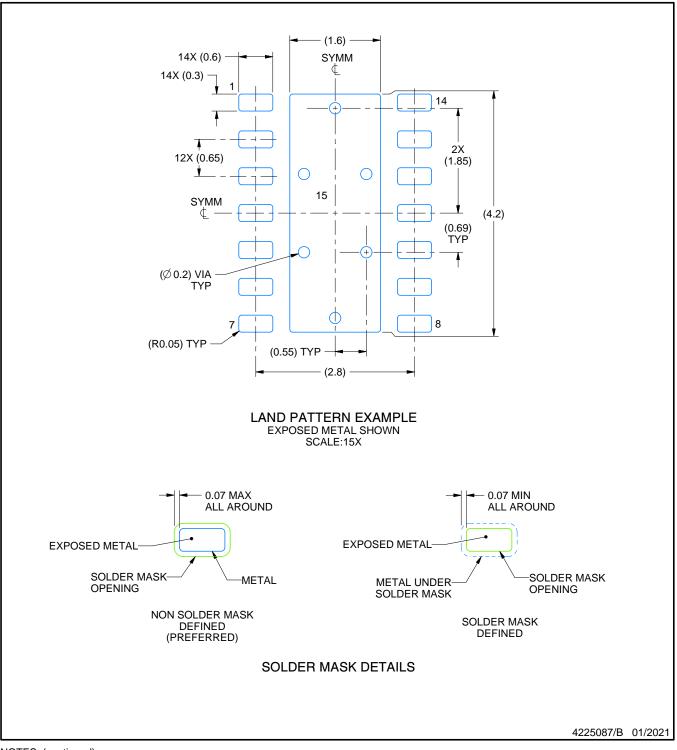


DMT0014B

EXAMPLE BOARD LAYOUT

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

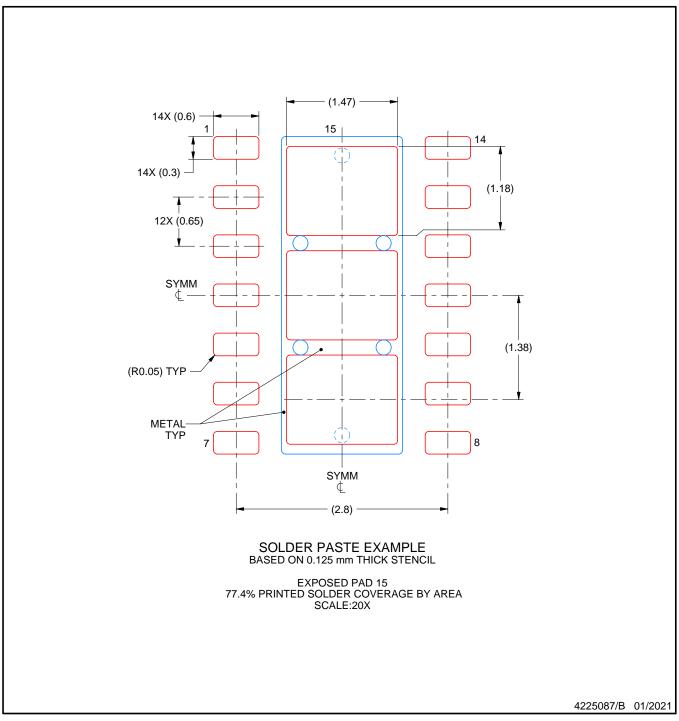


DMT0014B

EXAMPLE STENCIL DESIGN

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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